

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Molex Connector Corporation 0736441107

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>



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	0736441107		<u>^</u>
	Active		and the second
verview:	HDM® Backplane Cor		
escription:		Backplane Header, Vertical, SMC, Press-Fit, Guide Post	
	Location A, Polarizing	Key Position D, 144 Circuits	
Documents:			
<u>3D Model</u>		Packaging Specification PK-70873-0818 (PDF)	
Drawing (PDF)		RoHS Certificate of Compliance (PDF)	
Agency Certification			Series image - Reference only
CSA		LR19980	
UL		E29179	EU ELV
Comoral			Not Reviewed
General		Declusione Connectore	
Product Family		Backplane Connectors	EU RoHS China RoHS
Series		73644	Not Reviewed
Application		Backplane	REACH SVHC
Comments		Standard Press-Fit	Not Reviewed
Component Type		PCB Header	Halogen-Free
Overview		HDM® Backplane Connector System	<u>Status</u>
Product Name		HDM®	Not Reviewed
UPC		800753302037	Need more information on product
			environmental compliance?
Physical			
Circuits (Loaded)		144	Email productcompliance@molex.com
Circuits (maximum)		144	Please visit the Contact Us section for an
Color - Resin		Black, Natural	non-product compliance questions.
Durability (mating cyc	es max)	250	
First Mate / Last Brea	ĸ	No	China ROHS Not Reviewed
Flammability		94V-0	ELV Not Reviewed
Guide to Mating Part		Yes	
Keying to Mating Part		Yes	
Material - Metal		Phosphor Bronze, Stainless Steel	
Material - Plating Mating		Gold	Search Parts in this Series
Material - Plating Termination		Gold	<u>73644</u> Series
	Ination		
Material - Resin		High Temperature Thermoplastic	Mates With
Number of Columns		24	73632 HDM+® Board-to-Board
Number of Pairs		Open Pin Field	Daughtercard Receptacle. 73780 HDM
Number of Rows		6	Board-to-Board Daughtercard Recepta
Orientation		Vertical	Doard-to-Doard Dauginercard Recepta
PC Tail Length		3.50mm	
PCB Locator		No	Application Tooling FAQ
PCB Retention		Yes	Tooling specifications and manuals are
PCB Thickness - Rec	ommended	2.50mm	found by selecting the products below.
Packaging Type		Tube	Crimp Height Specifications are then
Pitch - Mating Interfac	e	2.00mm	contained in the Application Tooling
Pitch - Termination Int		2.00mm	Specification document.
Plating min - Mating		0.762µm	Global
Plating min - Terminat	tion	0.051µm	Description Product #
Polarized to PCB		No	Extraction Tool 0621001000
Stackable		Yes	Backplane Insertion 0621001400
Surface Mount Compa	atible (SMC)	Yes	Signal Contact Tool
Temperature Range -		-55°C to +105°C	Backplane Insertion 0622005703
Termination Interface:	1 0	Through Hole - Compliant Pin	Head for 144 Circuits
remination interface:	Otyle		
Electrical			
Electrical			



Current - Maximum per Contact Data Rate Real Signals (per 25mm) Shielded Voltage - Maximum 1.0A 1.0 Gbps 75 No 250V AC

Reference - Drawing Numbers

Material Info

Packaging Specification Sales Drawing PK-70873-0818 SDA-73644-****

Note: HDM, HDM+, VHDM, VHDM-HSD and GbX are trademarks or registered trademarks of Amphenol TCS.

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